

# MSKSEMI 美森科

SEMICONDUCTOR



ESD



TVS



TSS



MOV



GDT



PLED

## CD4011

产品规格手册

## 概述

CD4011 是一款采用 CMOS 技术设计的低功耗宽范围工作电压的 2 输入与非门集成电路。它内部集成 4 组相互独立的 2 输入与非门电路，具有高抗干扰能力和驱动能力。

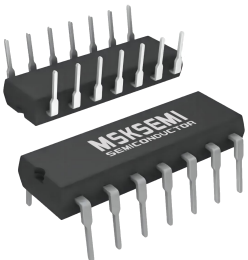
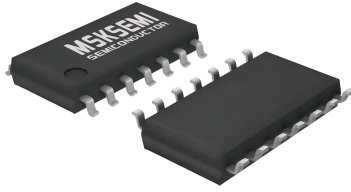
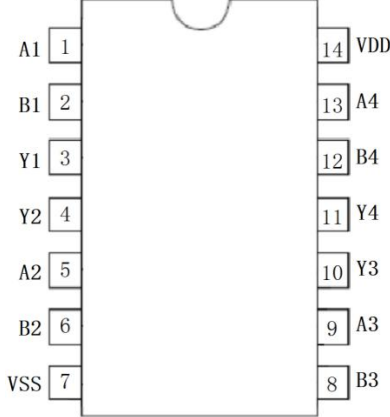
## 产品用途

- 数字逻辑驱动
- 无线门铃
- 工控应用
- 其它应用领域

## 特征

- 低输入电流： $I_{IN} \leq 1\mu A$ , @  $V_{IN}=V_{DD}=15V$ ,  $T_a=25^\circ C$
- 低静态功耗： $I_{DD} \leq 6\mu A$ , @  $V_{DD}=15V$ ,  $T_a=25^\circ C$
- 宽工作电压范围：3.0V to 15.0V
- 封装形式：DIP-14、SOP-14

## 参考信息

封装图		脚位信息
		
DIP-14	SOP-14	DIP14/SOP14 管脚功能定义

## 封装形式和管脚功能定义

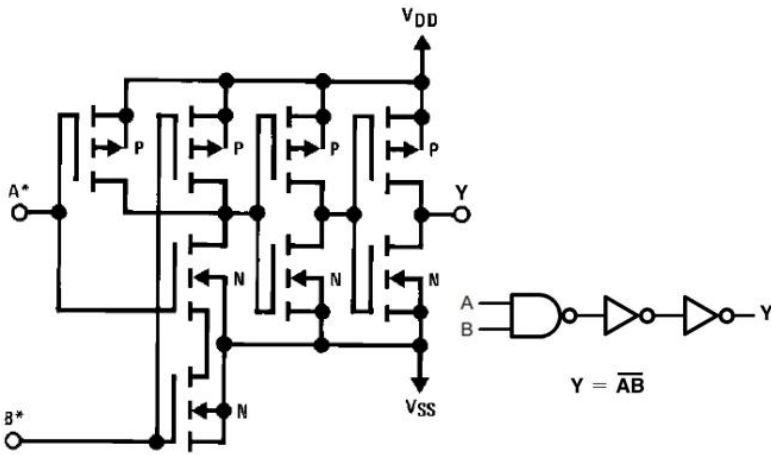
管脚序号	管脚定义	管脚序号	管脚定义
DIP14/SOP14		DIP14/SOP14	
1	A1	14	VDD
2	B1	13	B4
3	Y1	12	A4
4	Y2	11	Y4
5	A2	10	Y3
6	B2	9	B3
7	VSS	8	A3

**极限值**

参数	符号	极限值	单位
电源电压	$V_{DD}$	-0.5-18	V
输入电压	$V_{IN}$	-0.5+VSS- $V_{DD}$ +0.5V	V
功耗	$P_D$	500	mW
工作温度	$T_A$	0-70	°C
存储温度	$T_S$	-65-150	°C
引脚焊接温度	$T_W$	260, 10s	°C

注: 极限参数是指无论在任何条件下都不能超过的极限值。如果超过此极限值, 将有可能造成产品劣化等物理性损伤; 同时在接近极限参数下, 不能保证芯片可以正常工作。

**原理逻辑图**



**真值表**

Inputs		Output
A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

H = High Logic Level

L = Low Logic Level

推荐工作条件

项目	符号	最小值	典型值	最大值	单位
工作电压	V <sub>DD</sub>	2.5		15	V
输入输出电压	V <sub>IN</sub> 、V <sub>out</sub>	0		V <sub>DD</sub>	V
工作温度	T <sub>A</sub>	0		60	°C

电学特性

直流电学特性： T<sub>A</sub>=25°C

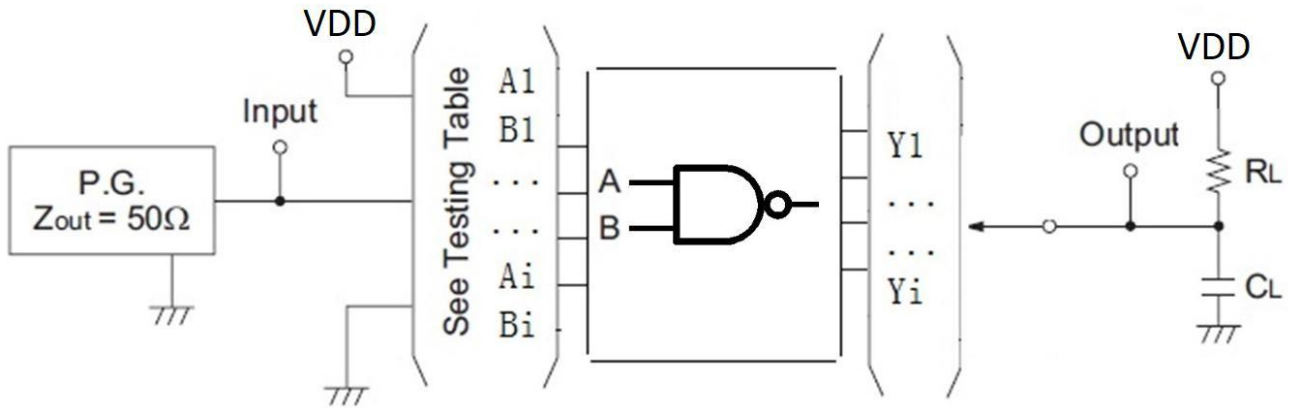
符号	项目	测试条件	VDD (V)	最小值	典型值	最大值	单位	
V <sub>IH</sub>	高电平有效输入电压	I <sub>O</sub>   ≤ 1uA	V <sub>O</sub> = 0.5V	5	3.5		V	
			V <sub>O</sub> = 1V	10	7.0		V	
			V <sub>O</sub> = 1.5V	15	11.0		V	
V <sub>IL</sub>	低电平有效输入电压	I <sub>O</sub>   ≤ 1uA	V <sub>O</sub> = 4.5V	5		1.5	V	
			V <sub>O</sub> = 9V	10		3.0	V	
			V <sub>O</sub> =13.5V	15		4.0	V	
V <sub>OH</sub>	高电平输出电压	I <sub>OUT</sub>   < 1uA	5	4.95			V	
			10	9.95			V	
			15	14.95			V	
V <sub>OL</sub>	低电平输出电压	I <sub>OUT</sub>   < 1uA	5			0.05	V	
			10			0.05	V	
			15			0.05	V	
I <sub>IN</sub>	输入电流	V <sub>IN</sub> =V <sub>DD</sub> or V <sub>SS</sub>	15		0.01	1.0	uA	
I <sub>OH</sub>	高电平输出电流		V <sub>O</sub> = 4.6V	5		-1.0	-0.5	mA
			V <sub>O</sub> = 9.5V	10		-2.1	-1.3	mA
			V <sub>O</sub> = 13.5V	15		-8.0	-3.4	mA
I <sub>OL</sub>	低电平输出电流		V <sub>O</sub> = 0.4V	5	0.5	2.2		mA
			V <sub>O</sub> = 0.5V	10	1.3	5.1		mA
			V <sub>O</sub> = 1.5V	15	3.4	19		mA
I <sub>DD</sub>	工作电流	V <sub>IN</sub> =V <sub>DD</sub> or V <sub>SS</sub>	5		0.1	4	uA	
			10		0.1	5	uA	
			15		0.1	6	uA	

交流电学特性： T<sub>a</sub>=25°C , R<sub>L</sub>=197k, C<sub>L</sub>=51pF 见测试方法。

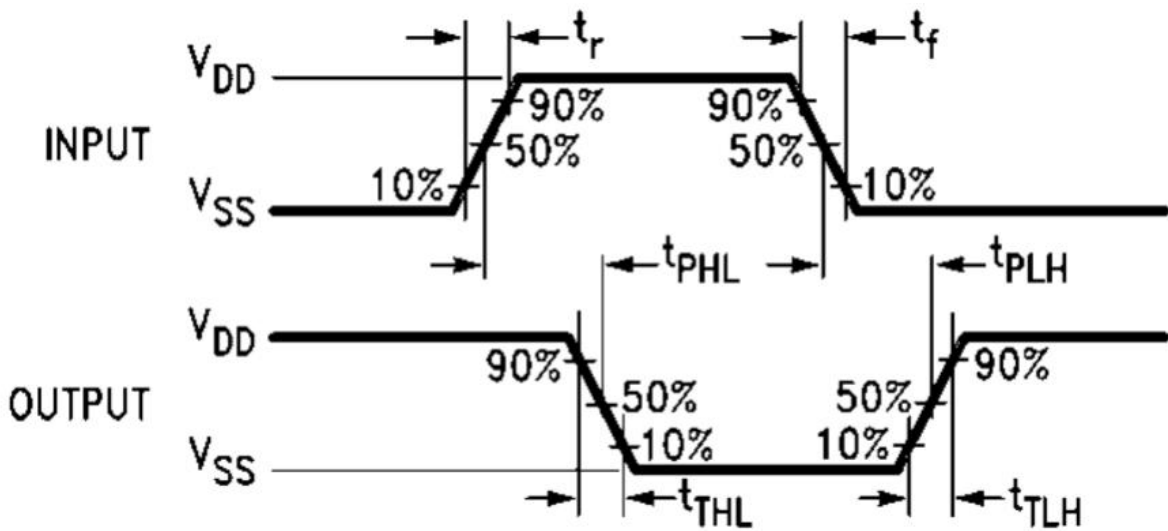
项目	符号	测试条件	最小值	典型值	最大值	单位
最大传输延迟时间 A、B to Y	t <sub>PHL</sub>	V <sub>DD</sub> =5V		62		ns
	t <sub>PLH</sub>			55		ns
	t <sub>PHL</sub>	V <sub>DD</sub> =10V		35		ns
	t <sub>PLH</sub>			35		ns
	t <sub>PHL</sub>	V <sub>DD</sub> =15V		30		ns
	t <sub>PLH</sub>			28		ns

## 测试方法

### 1、测试接线图



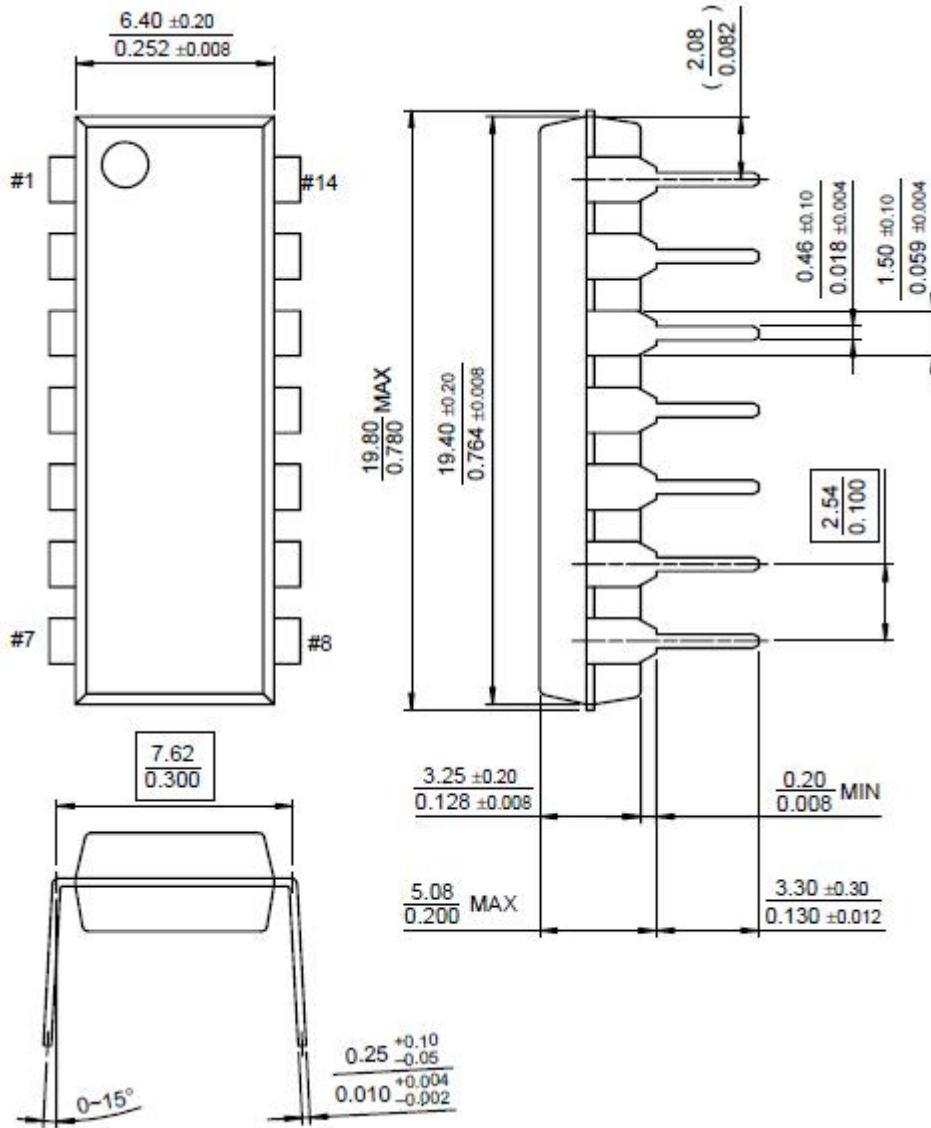
### 2、波形测量示意图



- 注：
- 1、See Testing Table 指交流电学特性表中相应测试项目；
  - 2、 $C_L$  电容为外接贴片电容(0603)，靠近输出管脚接入，电容地靠近芯片  $V_{SS}$ ；
  - 3、Input: 端口输入电平， $f=1\text{MHz}$ ,  $D=50\%$ 方波， $t_r=t_f \leq 20\text{ns}$ ；
  - 4、Output: Y 端输出测试。

DIP-14 包装数据

单位：毫米 / 英寸

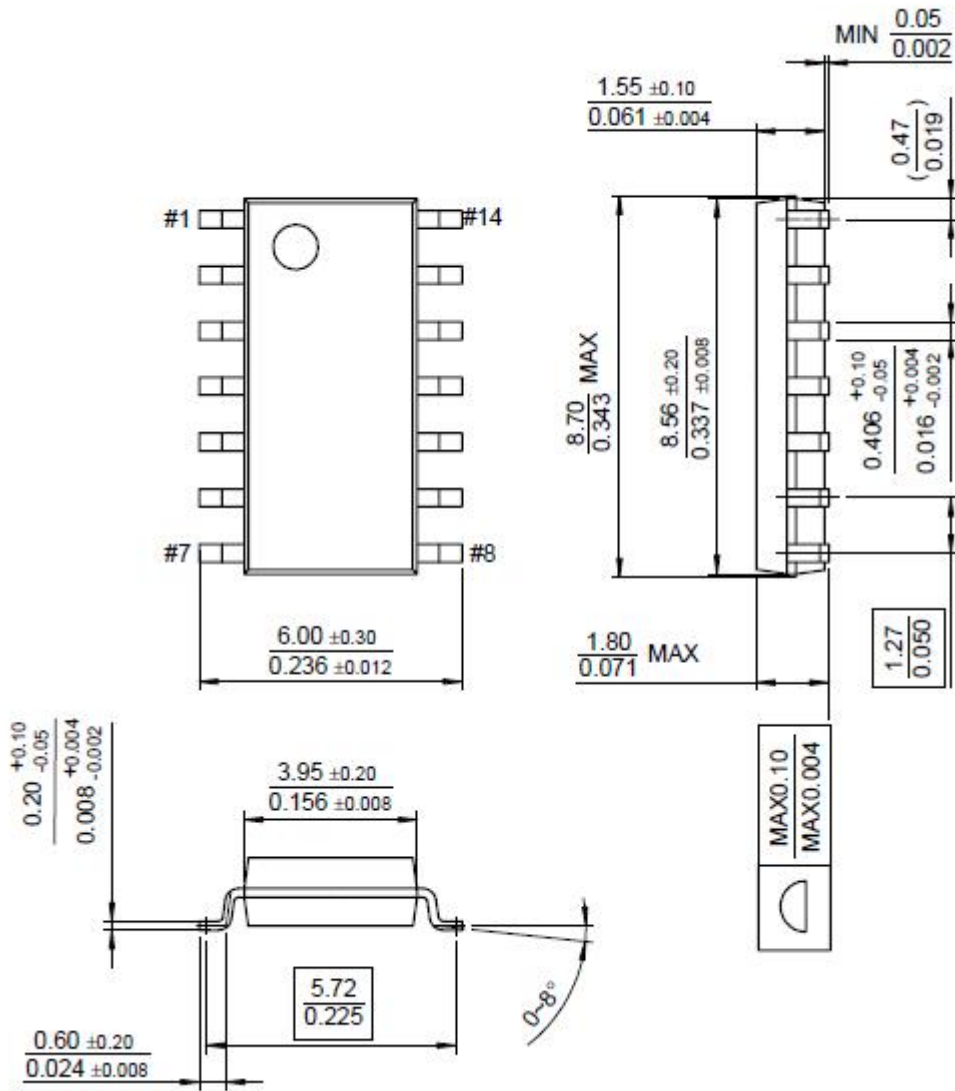


卷轴规格

P/N	PKG	QTY
CD4011BE-MS	DIP-14	1000

SOP-14 包装数据

单位：毫米 / 英寸



卷轴规格

P/N	PKG	QTY
CD4011BM-MS	SOP-14	2500

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[74LVC1G08Z-7](#) [74LVC32ADTR2G](#) [CD4025BE](#) [MC74HCT20ADTR2G](#) [NLV17SZ00DFT2G](#) [NLV17SZ126DFT2G](#) [NLV27WZ17DFT2G](#)  
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